



User Manual

PIM-Carrier-6U

PMC Interface Module Carrier

Dual PIM carrier in 6U rear plate configuration

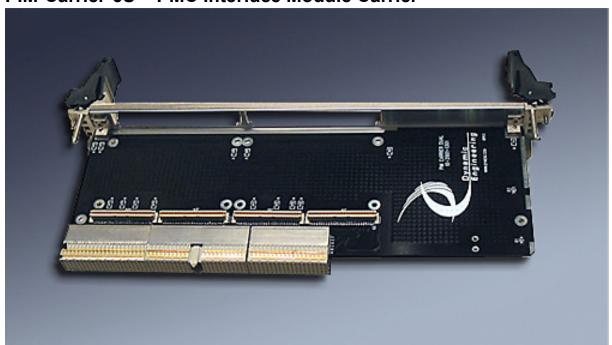
Manual Revision 01p1
Revision Date 8/26/2020
Corresponding Hardware 10-2001-13(01-04)

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Est. 1988

PIM-Carrier-6U - PMC Interface Module Carrier



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Cautions and Warnings

The electronic equipment described herein generates, uses, and can radiate radio frequency energy. Operation of this equipment in a residential area is likely to cause radio interference, in which case the user, at their own expense, will be required to take whatever measures may be required to correct the interference.

Dynamic Engineering's products are not authorized for use as critical components in life support devices or systems without express written approval from the president of Dynamic Engineering.

Connection of incompatible hardware is likely to cause serious damage.

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Design Revision History

Table 1: Design Revision History

Revision	Date	Description
Α	2001	Initial release of design
В	3/27/2006	Updated for RoHS – footprints etc.
B2	6/20/2006	Added more decoupling Corrected ESD strip
C1	4/24/2007	No schematic changes; shrank bd. Outline, fixed cPCI connectors, new contact information
04	8/24/2020	Updated to 0402, current fiducials etc.

Manual Revision History

Table 2: Manual Revision History

Revision	Date	Description	
NOTE: Revisions released prior to August 2020 may have incomplete data			
01p1	8/26/2020	Initial release of manual	

NOTE: Dynamic Engineering has made every effort to ensure that this manual is accurate and complete; that being said, the company reserves the right to make improvements or changes to the product described in this document at any time and without notice. Furthermore, Dynamic Engineering assumes no liability arising out of the application or use of the device described herein.

Product Description

PIM(s) combined with PIM-Carrier facilitates rear panel I/O in cPCI based systems using PMCs and XMCs. Instead of trying to connect wires to the backplane pins, a PIM mounted to a PIM-Carrier provides a method of connecting rear panel I/O from a cPCI PMC carrier to the rear I/O panel. The I/O from Jn4/Jn6 is routed to the cPCI connectors allocated to rear I/O. The PIM carrier mounts on the underside of the motherboard with the PIMs acting like mini PMCs.

The PMC Carrier routes the PMC I/O from P04/P14 to J3/J5. PIM-Carrier-6U routes the I/O from J3/J5 to the two PIM positions. The PIMs route the I/O to the bezel providing the equivalent of PMC front bezel I/O on the rear of the chassis. The PIM can match the pinout of the front bezel I/O to allow for common cables to be used for front and rear I/O. Alternate connectors and pinouts can also be used.

Dynamic Engineering has several PIM designs to meet your needs. For example, PIM-Universal-IO has 1:1 connections from the rear I/O to the SCSI connector. The Pn4 User I/O on the PMC is routed through the host carrier board to the backplane. Specialized PIMs can be designed for your requirements. In addition, the PIMs and carrier can be integrated for production projects to lower cost and make more extensive use of the rear panel I/O space.

The PIM specification provides for power and ground references. The 5V and ground references routed to the PIMs from the defined rear-I/O pins.

PIM-Carrier-6U is compatible with cPCIBPMC6UET and two-position cPCIBPMC6U32 extended temperature PMC carriers. Some carriers use alternate pin definitions. Please check that the PIM-Carrier-6U will properly interconnect with your carrier.

NOTE: PIM-Carrier-6U was previously called the PIM-Carrier-Dual



Figure 1: PIM-Carrier-6U Schematic (part 1 of 2)

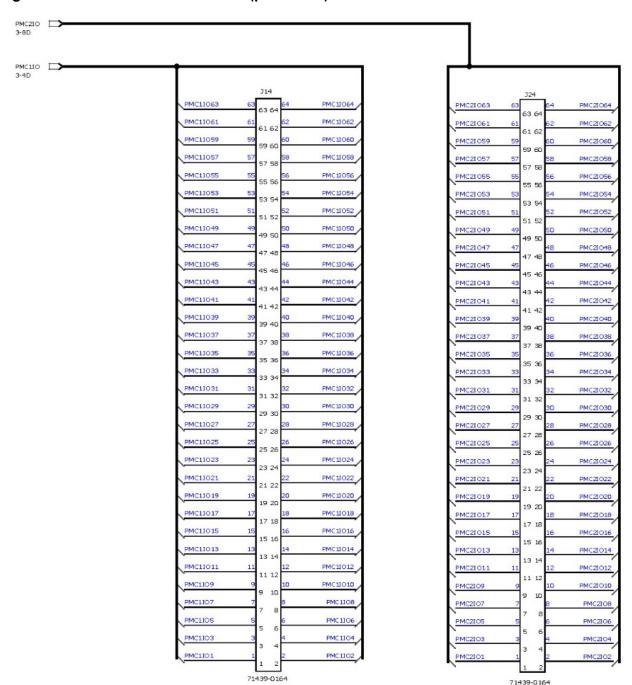
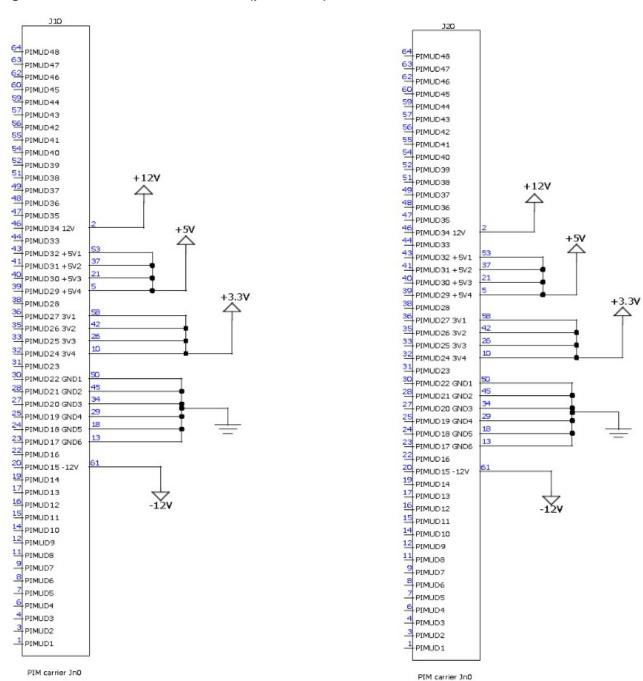


Figure 2: PIM-Carrier-6U Schematic (part 2 of 2)



Key Product Features

Table 3: Key Product Features

Feature	Description	
Signal Routing	Use PIM-Carrier-6U to route PMC/XMC signals for rear panel applications	
Mounting Positions	Mounting positions for two PIM units	
I/O	Matched-length, impedance-controlled I/O	
Bezel	Rear plate with PIM bezel mounting	

Product Specifications

Table 4: Product Specifications

Specification	Description
Carrier Connector	J3, J5
Bezel	Rear-mounting plate with two PIM cutouts

Construction and Reliability

PIMs are conceived and engineered for rugged industrial environments. The PIM-Carrier-6U is constructed out of 0.062-inch thick, high-temp FR4 material.

Through-hole and surface mounting of components are used. High insertion and removal forces are required, which assists in the retention of components. The stand-offs should be used to mount the PIM to the PIM carrier to provide added protection against vibration induced intermittent connections.

The PMC Module connectors are keyed and shrouded with Gold-Plated pins on both plugs and receptacles. They are rated at 0.5 Amp per pin, 200 insertion cycles minimum. These connectors make consistent, correct insertion easy and reliable.

The PIM-Carrier-6U is entirely passive.

Installation and Interfacing Guidelines

Some general interfacing guidelines are presented below. If you need more assistance, contact Dynamic Engineering.

Installation

Warning: Connection of incompatible hardware is likely to cause serious damage.

ESD

Safety and reliability can be achieved only by careful planning and practice. Inputs can be damaged by static discharge by applying voltage less than ground or more than +5 volts with the IP powered. With the IP unpowered, driven input voltages should be kept within 0.7 volts of ground potential.

Guidelines

Grounds - Watch the system grounds. All electrically connected equipment should have a fail-safe common ground that is large enough to handle all current loads without affecting noise immunity. Power supplies and power consuming loads should have all their own ground wires back to a common point.

Table 5: Interconnect List

Connector	Pin		
	Ground		
J3	F1, F3, F5, F7, F9, F11, F13, F15, F17, F19		
J4	F1, F3, F5, F7, F9, F11, F13, F15, F17, F19, F21,		
	F23, F25		
J5	F1, F3, F5, F7, F9, F11, F13, F15, F17, F19, F21		
J10	13, 18, 29, 34, 45, 50		
J20	13, 18, 29, 34, 45, 50		
	Minus 12V		
J10	61		
J20	61		
	Plus 3.3V		
J3	A14, B14, C14		
J10	10, 26, 42, 58		
J20	10, 26, 42, 58		
	Plus 5V		
J3	D14, E14		
J10	5, 21, 37, 53		
J20	5, 21, 37, 53		
Plus 12V			
J10	2		
J20	2		

J10, J14 = PIM 0

J20, J24 = PIM 1

J3, J4, J5 = cPCI Mating Connectors

NOTE: P12, M12 do not have defined source pins on J3, J4, J5 and are only interconnected between the PIMs. All voltages are decoupled on board. Special versions can be made with circuitry on the PIM carrier. Contact Dynamic Engineering with any specific requirements.

Pin Assignments

Table 6: PIM 1 (PMC 0) Pin List

Table 6. Fill I (Fill 0) Fill List			
PMC 0	PMC/PIM	PMC	
Signal	Carrier	Carrier	
P04	J3	J14	
1	E13	1	
2	E13 D13	2	
1 2 3 4 5 6	C13 B13	2 3 4 5 6 7	
4	B13	4	
5	A13	5	
6	E12	6	
7	D12	7	
8 9	C12	8	
	B12	8 9	
10	A13 E12 D12 C12 B12 A12 E11 D11 C11 B11 A11 E10 D10 C10	10	
11	E11	11	
12	D11	12	
13	C11	13	
14 15 16 17 18	B11	14 15 16 17 18	
15	A11	15	
16	E10	16	
17	D10	17	
18	C10	18	
19	B10	19	
19 20	B10 A10	20	
21	E9 D9	21	
22	D9	22	
21 22 23 24	C9 B9 A9	19 20 21 22 23 24	
24	B9	24	
25 26	A9	25 26	
26	F8	26	
27	D8	27	
27 28 29 30	D8 C8 B8	27 28 29 30	
29	B8	29	
30	I A8	30	
31 32	E7 D7	31 32	
32	D7	32	

PMC 0 Signal P04	PMC/PIM Carrier J3	PMC Carrier J14
33	C7	33
34	B7	34
35	A7	35
36	E6	36
37	D6	37
38	C6	38
39	B6	39
40	A6	40
41	E5	41
42	D5	42
43	C5	43
44	B5	44
45	B5 A5	45
46	E4	46
47	E4 D4 C4	47
48	C4	48
49	B4	49
50	A4	50
51	E3 D3 C3	51
52	D3	52
53	C3	53
54	B3	54
55	A3	55
56	E2	56
57	D2	57
58	C2	58
59	B2	59
60	A2	60
61	E1	61
62	D1	62
63	C1	63
64	B1	64

PIM-Carrier-6U User Manual **Table 7: PIM 2 (PMC 1) Pin List**

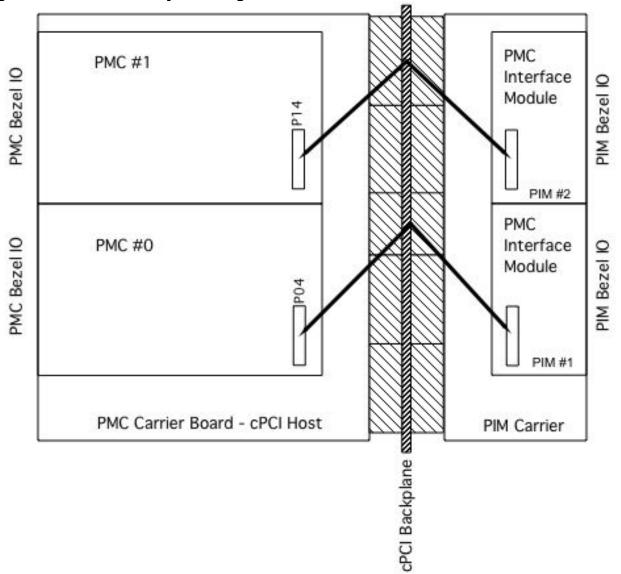
Table 7: PIM 2 (PMC 1) Pin List		
PMC 1	PMC/PIM	PMC
Signal	Carrier	Carrier
P14	J5	J24
1	E13	1
2	D13	2
3 4	C13	3 4
4	B13	
5	A13	5 6
6	E12	6
7	D12	7
8	C12	8
9	B12	9
10	Δ12	10
11	E11 D11 C11 B11	11
12 13	D11	12 13
13	C11	13
14	B11	14
15	A11	15
16	E10	16
17	D10	17
18	C10	18
19	B10	19
20	A10	20
21	E9	21
22 23 24	D9	22 23 24
23	C9	23
24	B9	24
25	A9	25
26	E8	26
27	D8	27
28	C8	28
29	B8	29
30	A8	30
31	E7	31
32	D7	32

PMC 1 Signal P14	PMC/PIM Carrier J5	PMC Carrier J24
33	C7	33
34	B7	34
35	A7	35
36	E6	36
37	D6	37
38	C6	38
39	B6	39
40	A6	40
41	E5	41
42	D5 C5	42
43	C5	43
44	B5	44
45	A5	45
46	E4	46
47	E4 D4	47
48	C4	48
49	B4	49
50	A4	50
51	E3	51
52	D3	52
53	C3	53
54	E3 D3 C3 B3	54
55	A3	55
56	E2 D2	56
57	D2	57
58	C2	58
59	B2	59
60	A2	60
61	E1	61
62	D1	62
63	C1	63
64	B1	64

System Diagram

The figure below shows the relative connections of the PIM installed into the PIM carrier. The carrier attached to the rear of the backplane and the host to the front of the backplane. The PMC is attached to the host. The Pn4 I/O is routed from the PMC to the PIM to provide the PIM Bezel I/O. With the PMC and PIM-Universal-IO combination, the Pn4 I/O is the same for the 64 I/O signals on the two connectors.

Figure 3: PIM-Carrier-6U System Diagram



Warranty and Repair

Please refer to the warranty page on our website for the warranty and options that are currently offered

www.dyneng.com/warranty

Service Policy

Before returning a product for repair, verify to the best of your ability, that the suspected unit is as fault. Then call the Dynamic Engineering Customer Service Department for a Return Material Authorization (RMA) number. Carefully package the product, in the original packaging if possible, and ship prepaid and insured with the RMA number clearly written on the outside of the package. Include a return address and the telephone number of a technical contact. For out-of-warranty repairs, a purchase order for repair charges must accompany the return. Dynamic Engineering will not be responsible for damages due to improper packaging of returned items. For service on Dynamic Engineering products not purchased directly from Dynamic Engineering, contact your reseller. Products returned to Dynamic Engineering for repair by anyone other than the original customer will be treated as out-of-warranty.

Out-of-Warranty Repairs

Out-of-warranty repairs will be billed on a material and labor basis. Customer approval will be obtained before repairing any item if the repair charges will exceed one half of the list price for one of that kind of unit. Return transportation and insurance will be billed as part of the repair in addition to the minimum RMA charge.

Contact:

Customer Service Department Dynamic Engineering 150 DuBois St. Suite C Santa Cruz, CA 95005 (831) 457-8891 support@dyneng.com

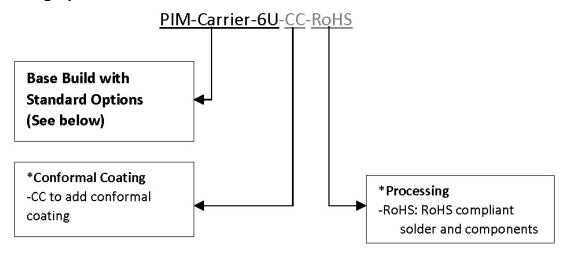
Ordering Information

Standard Temperature Range-Rated Components: -40 - 85°C

Table 8: Ordering Information

Product	Description		
PIM-Carrier-6U	PIM carrier with mounting positions for two PIM units. Rear plate with PIM bezel mounting. www.dyneng.com/PIM-Carrier-6U		
	Options:		
PIM-Carrier-6U	-RoHS	Use RoHS processing. Standard processing is "leaded."	
	-CC	Option to add conformal coating	
cPCIBPMC6UET	Two-position extended temperature PMC carrier www.dyneng.com/cPCIBPMC6UET		
SCSI Cable: HDEcabl68	HDEcabl68 provides a SCSI compliant cable with either latch block or screw terminal retention. www.dyneng.com/HDEcabl68		
HDEterm68	SCSI II cable interface to 68-screw terminals. Comes with DIN rail mounting capability www.dyneng.com/HDEterm68		

Figure 4: Ordering Options PIM-Carrier-6U



PIM-Carrier-6U comes standard with two mounting positions for PIM units and a rear plate with PIM bezel mounting
*Only include the build option(s) desired
Ex. PIM-Carrier-6U-RoHS

Dynamic Engineering PIM-Carrier-6U Ordering Options Revision 01, August 26, 2020

Glossary

Baud Used as the bit period when talking about UARTs; Not strictly correct, but is

the common usage when talking about UARTs.

CardID Unique number assigned to a design to distinguish between all designs of a

particular vendor

CFM Cubic feet per minute

FIFO First In First Out memory

Flash Non-volatile memory used on Dynamic Engineering boards to store FPGA

configurations or BIOS

JTAG Joint Test Action Group – a standard used to control serial data transfer for

test and programming operations.

LFM Linear feet per minute

LVDS Low Voltage Differential Signaling

MUX Multiplexor – multiple signals multiplexed to one with a selection

mechanism to control which path is active.

Packed When UART characters are always sent/received in groups of four, allowing

full use of host bus/FIFO bandwidth

Packet Group of characters transferred. When the characteristics of the group of

characters is known, the data can be stored in packets and transferred as such; the system is optimized as a result. Any number of characters can be

transferred.

PCI Peripheral Component Interconnect – parallel bus from host to this device

PIM PMC Interface Module (PIM). Provides rear I/O in cPCI systems. Mounts to

PIM Carrier

PIM Carrier PIM Mounting Device. Mounts on rear of cPCI backplane.

PMC PCI Mezzanine Card – establishes common connectors, connections, size

and other mechanical features.

TAP Test Access Port – basically a multi-state port that can be controlled with

JTAG [TMS, TDI, TDO, TCK]. The TAP States are the states in the State Machine that are controlled by the commands received over the JTAG link.

TCK Test Clock provides synchronization for the TDI, TDO, and TMS signals

TDI Test Data in – this serial line provides the data input to the device controlled

by the TMS commands. For example, the data to program the FLASH comes on the TDI line while the commands to the state machine to move through the necessary states comes over TMS. Rising edge of TCK valid.

TDO Test Data Out is the shifted data out. Valid on the falling edge of the TCK.

Not all states output data.

TMS Test Mode State – this serial line provides the state switching controls. '1'

indicates to move to the next state, '0' means stay put in cases where delays can happen; otherwise, 0,2 are used to choose which branch to take. Due to the complexity of state manipulation, the instructions are

usually precompiled. Rising edge of TCK valid.

UART Universal Asynchronous Receiver Transmitter. Common serialized data

transfer with start bit, stop bit, optional parity, optional 7/8 bit data. Can be

over any electrical interface. RS232 and RS422 are most common.

Unpacked When UART characters are sent on an unknown basis requiring single

character storage and transfer over the host bus

VendorID Manufacturers number for PCI/PCIe boards. DCBA is Dynamic

Engineering's VendorID

VME Versa Module European

VPX Family of standards based on the VITA 46.0

XMC Switched mezzanine card (PMC with PCIe)